

FDMS8674

N-Channel PowerTrench[®] MOSFET

30V, 21A, 5.0mΩ

Features

- Max $r_{DS(on)}$ = 5.0m Ω at V_{GS} = 10V, I_D = 17A
- Max r_{DS(on)} = 8.0mΩ at V_{GS} = 4.5V, I_D = 14A
- Advanced Package and Silicon combination for low $r_{\text{DS}(\text{on})}$ and high efficiency
- MSL1 robust package design
- RoHS Compliant

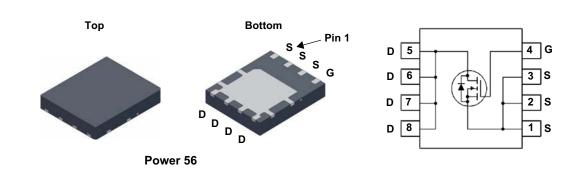


General Description

The FDMS8674 has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{\text{DS(on)}}$ while maintaining excellent switching performance.

Applications

- Computing VR & IMVP Vcore
- Secondary Side Synchronous Rectifier
- POL DC/DC Converter
- Oring FET/ Load Switch



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25°C		21		
	-Continuous (Silicon limited)	T _C = 25°C		94		
	-Continuous	T _A = 25°C	(Note 1a)	17	A	
	-Pulsed			150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	181	mJ	
P _D	Power Dissipation	T _C = 25°C		78		
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)		(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

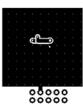
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8674	FDMS8674	Power 56	13"	12mm	3000units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C	00	25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24V, V _{GS} = 0V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics	1				
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C	1.0	-6	0.0	mV/°C
<u> </u>		V _{GS} = 10V, I _D = 17A		4.1	5.0	
DS(on)	Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 14A		5.8	8.0	mΩ
20(01)		V _{GS} = 10V, I _D = 17A, T _J = 125°C		5.8	8.3	1
9 _{FS}	Forward Transconductance	$V_{DD} = 10V, I_D = 17A$		87		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1745	2320	pF
C _{oss}	Output Capacitance	$-V_{DS} = 15V, V_{GS} = 0V,$		860	1145	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		130	195	pF
R _g	Gate Resistance	f = 1MHz		0.9		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Rise Time	V _{DD} = 15V, I _D = 17A,		4	10	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GS} = 10V, R_{GEN} = 6\Omega$		26	42	ns
t _f	Fall Time	-		3	10	ns
Q _g	Total Gate Charge	V _{GS} = 0V to 10V		26	37	nC
Q _g	Total Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 15V,$		14	20	nC
Q _{gs}	Gate to Source Charge	$I_D = 17A$		4.8		nC
Q _{gd}	Gate to Drain "Miller" Charge	_		3.5		nC
Drain-Sou	urce Diode Characteristics					
	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = 2.1A (Note 2)		0.7	1.2	V
V _{SD}	Source to Drain Diode Forward voltage	V _{GS} = 0V, I _S = 17A		0.8	1.2	V
t _{rr}	Reverse Recovery Time	—I _F = 17A, di/dt = 100A/μs		40	64	ns
Q _{rr}	Reverse Recovery Charge	F = 17A, divit = 100A/µs		30	48	nC



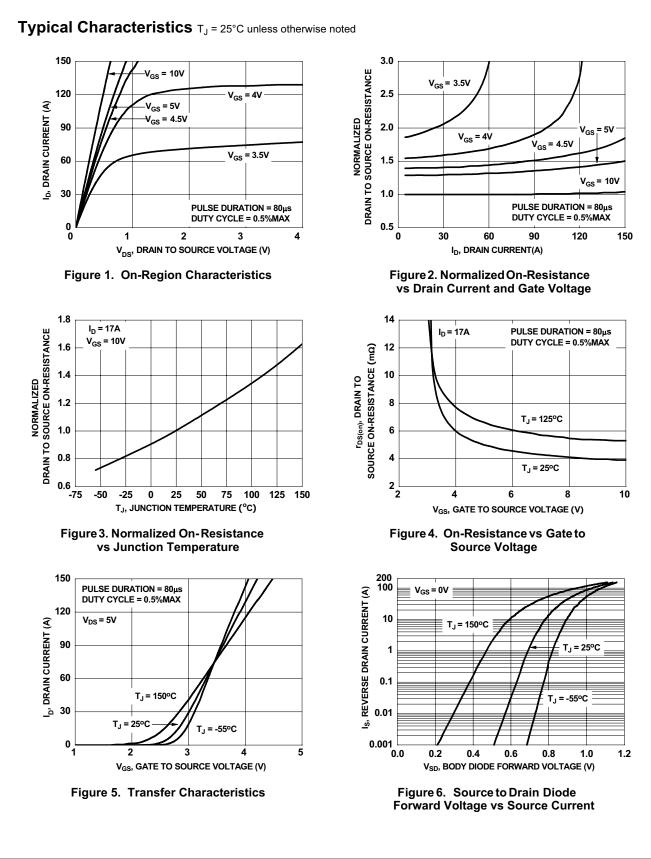




2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25°C, L = 3mH, I_{AS} = 11A, V_{DD} = 30V, V_{GS} = 10V.

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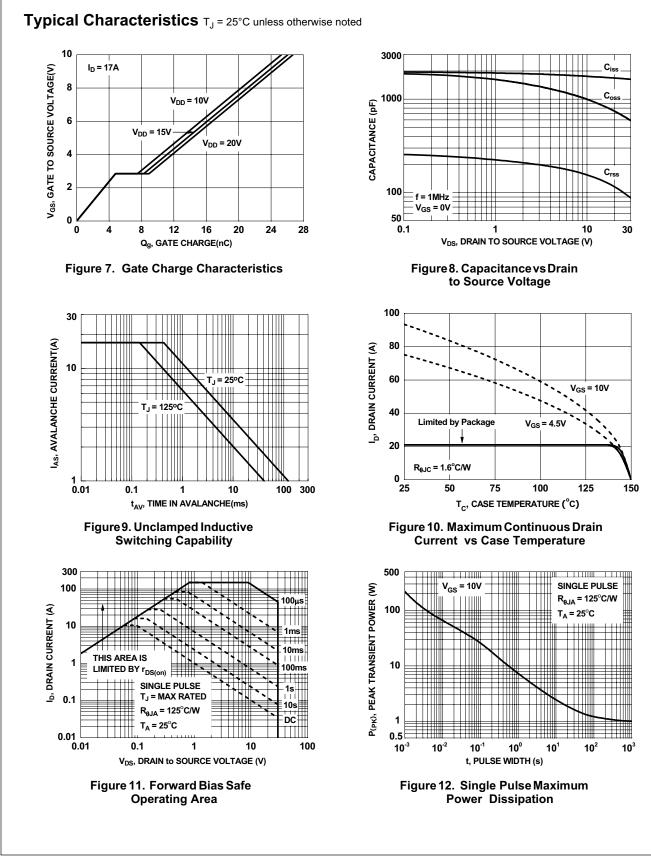
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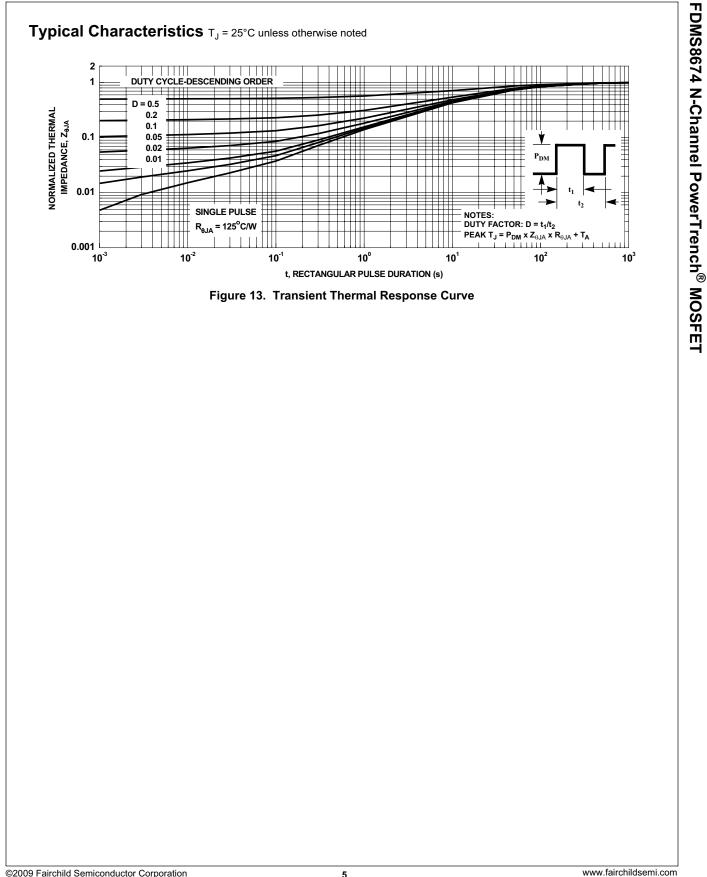
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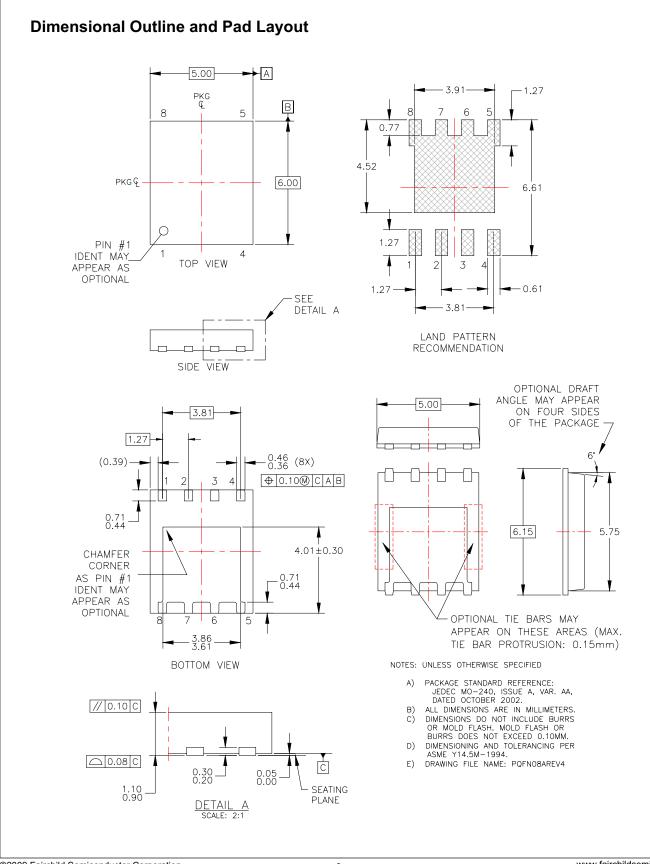


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6



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